<u>REMARKS</u>

In the outstanding Office Action, the Examiner objected to the drawings for failing to comply with 37 C.F.R. § 1.84 (p)(5); objected to the specification for various informalities; objected to the specification for failing to provide proper antecedent basis in claims 3-5 and 38-39; objected to the drawings under 37 C.F.R. § 1.83(a) for failing to show every feature of the claims; objected to claims 1, 2 and 39, for various informalities; rejected claims 1-5 and 34-39 under 35 U.S.C. § 112, second paragraph for being indefinite; rejected claims 1, 2, 35 and 36 under 35 U.S.C. § 102(b) as being anticipated by U.S. Patent No. 5,306,940 to Yamazaki ("Yamazaki"); and rejected claims 1-5 and 34-39 under 35 U.S.C. § 102(e) as being anticipated by U.S. Patent No. 6,087,706 to Dawson et al. ("Dawson").

By this amendment, Applicants amend claims 1-4 and 35-39. Claims 1-5 and 34-39 remain pending.

Objections to the Drawings

Objections under 37 C.F.R. § 1.84(p)(5)

The Examiner objected to the drawings as failing to comply with 37 C.F.R. § 1.84(p)(5), for including reference characters not included in the specification. Specifically, the Examiner objects to reference character "21" in Figure 4A as not being included in the specification. The Examiner further objected to the specification for specifically referencing the monocrystalline silicon substrate as reference character "41" at page 32 line 3. Accordingly, Applicants have amended the specification at page 32, line 3 to replace reference character "41" with reference character 21.

Objections under 37 C.F.R. § 1.83(a)

The Examiner further objected to the drawings under 37 C.F.R. § 1.83(a) for failing to show every feature of the claimed invention. This objection coincides with the objection to the specification for failing to provide proper antecedent basis for the claimed subject matter. These two objections will be discussed together below.

Objections to the Specification

The Examiner first objected to the specification for various informalities.

Applicants have corrected the specification at pages 31-31 and 61-62, as indicated in the above Amendment to the Specification section of this paper.

Additionally the Examiner objected to the specification for failing to provide proper antecedent basis for the claimed subject matter, and, for similar reasons, objected to the drawings for failing to show every feature of the claimed invention.

Although Applicants do not necessarily agree with the Examiner's characterization of the specification and drawings, Applicants have amended claims 3-4 and 38-39 to address the Examiner's concerns.

With respect to claim 5, however, the Examiner appears to assert that the language "the difference in height from said substrate between the top surface position of said semiconductor layer and the top surface position of said element isolating insulating element is substantially at least a junction depth of said source/drain region," as recited in claim 5, is not described in the specification, or shown in the drawings.

Applicants respectfully disagree.

Applicants respectfully submit that the specification indeed provides support for claim 5. The specification describes the relationship between "the step amount δ , and

the threshold voltage V_{th} for MOS transistors of different junction depths x_j ." Applicants' specification, page 58, lines 5-11. Moreover, corresponding Figure 15 shows a series of curves for different junction depths x_j including points wherein the step amount δ is substantially the same as the junction depth x_j , thereby providing exemplary support for the claimed "the difference in height from said substrate between the top surface position of said semiconductor layer and the top surface position of said element isolating insulating element is substantially at least a junction depth of said source/drain region," as recited in claim 5. Accordingly, Applicants respectfully request the objections to the drawings and the specification be withdrawn.

Objections to the Claims

The Examiner objected to claims 1, 2, and 39 for failing to provide proper antecedent basis. Specifically the Examiner stated:

"[c]laim 1, line 8 the phrase 'the element regions' has no antecedent basis ... [c]laim 2, line 8, the phrase 'said element regions' has no antecedent basis ... [c]laim 39, line 2 the phrase 'the gate insulating film' has no antecedent basis." Office Action, page 4, lines 13-16.

With respect to claims 1 and 2, Applicants submit that claims 1 and 2 have been amended to recite a combination including at least, "element regions," thus providing proper antecedent basis.

With respect to claim 39, which depends from claim 2, Applicants submit that claim 2 has been further amended to include a recitation of "a gate insulating film," thus providing proper antecedent basis for "the gate insulating film" recited in claim 39.

Accordingly, Applicants respectfully request that the objections to claims 1, 2, and 39 be withdrawn.

Rejection under 35 U.S.C. § 112, second paragraph

The Examiner rejected claims 1-5 and 34-39 under 35 U.S.C. § 112, second paragraph, as being indefinite. Specifically, the Examiner appears to assert that the phrase "an element isolating film provided in the trench for partitioning said semiconductor layer into an element region," as recited in claims 1-3, is vague and indefinite. Although Applicants do not necessarily agree with the Examiner's characterization of claims 1-3, Applicants have amended claims 1-3 to recite a combination including, "an element isolating film provided in the trench for partitioning said semiconductor layer into a plurality of element regions." Accordingly, Applicants respectfully request the rejection of claims 1-5 and 34-39 under 35 U.S.C. § 112, second paragraph, be withdrawn.

Rejections under 35 U.S.C. §§ 102(b), 102(e)

Regarding the rejection of claims 1-2 and 35-36 under 35 U.S.C. § 102(b) as being anticipated by <u>Yamazaki</u>, and claims 1-5 and 34-39 under 35 U.S.C. § 102(e) as being anticipated by <u>Dawson</u>, Applicants respectfully disagree with the Examiner's arguments and conclusions as set forth in the outstanding Office Action. Accordingly, Applicants respectfully traverse these rejections.

In order to properly anticipate Applicants' claimed invention under 35 U.S.C. §102, each and every element of the claim in issue must be found, "either expressly or inherently described, in a single prior art reference." "The identical invention must be shown in as complete detail as is contained in the . . . claim. *Richardson v. Suzuki Motor Co.*, 868 F.2d 1226, 1236, 9 USPQ2d 1913, 1920 (Fed. Cir. 1989)." See M.P.E.P. § 2131, (8th ed., 2001).

Yamazaki

Applicants respectfully traverse the Examiner's rejection of claims 1-2 and 35-36 under 35 U.S.C. § 102(b) as being anticipated by <u>Yamazaki</u>. Claim 1, for example, is not anticipated by <u>Yamazaki</u> because the reference fails to teach each and every element of the claim. In particular, <u>Yamazaki</u> at least fails to teach the claimed combination including "a difference in height from the substrate between the top surface position of said element isolating insulating film and the top surface position of said semiconductor layer is at least three times as large as the thickness of said gate insulating film," as recited in claim 1.

The Examiner contends that <u>Yamazaki</u> teaches "a trench (the area occupied by the lower portion of the oxide film [110])." Office Action at pages 5 and 10. Element 110 in <u>Yamazaki</u> is a field oxide (col. 14, lines 65-67), however, and the lower portion of which does not constitute a trench. On the other hand, <u>Yamazaki</u> clearly identifies element 112 as a "trench." See, for example, col. 15, lines 2-7. If the lower portion of field oxide film 110 were a trench, <u>Yamazaki</u> would have disclosed it as such. Claim 1, therefore, is distinguishable over <u>Yamazaki</u> at least for this reason.

Applicants note that trenches 112 of <u>Yamazaki</u> include a BPSG film 115c, which arguably corresponds to the claimed element isolating insulating film (see Fig. 8C, col. 15, lines 2-7). BPSG film 115c, however, does not extend above a surface of epitaxial layer 103 between trenches 112 (see Fig. 8c). Accordingly, <u>Yamazaki</u> does not teach the claimed combination including "a difference in height from the substrate between the top surface position of said element isolating insulating film and the top surface position

of said semiconductor layer is at least three times as large as the thickness of said gate insulating film," and claim 1 is distinguishable over <u>Yamazaki</u> for this reason as well.

Claim 2, while of different scope, recites limitations similar to those recited in claim 1. Claim 2 is therefore distinguishable over Yamazaki for reasons discussed above in regard to claim 1.

In light of the above-described deficiencies of <u>Yamazaki</u>, Applicants submit that claims 1 and 2 are allowable over the applied reference, and claims 35 and 36 are allowable at least due to their dependence from claims 1 and 2, respectively.

<u>Dawson</u>

Applicants respectfully traverse the Examiner's rejection of claims 1-5 and 34-39 under 35 U.S.C. § 102(e) as being anticipated by <u>Dawson</u>. Claim 1, for example, is not anticipated by <u>Dawson</u> because the reference fails to teach each and every element of the claim. In particular, <u>Dawson</u> at least fails to teach the claimed combination including "an element isolating insulating film," as recited in claim 1.

The Examiner apparently contends that trench fill material 80 and dielectric layer 5 of <u>Dawson</u> correspond to the claimed element isolating insulating film, as recited in claim 1. Trench fill material 80 does not extend above the surface of substrate 10 (see Fig. 4G), and thus cannot constitute the claimed element isolating insulating film such that "a difference in height from the substrate between the top surface position of said element isolating insulating film and the top surface position of said semiconductor layer is at least three times as large as the thickness of said gate insulating film," as recited in claim 1.

The Examiner also contends that <u>Dawson</u> teaches a "trench (the area occupied by the lower portion of the dielectric film [5] and the dielectric film [80])." Office Action at page 7. To the extent the Examiner's position is understood, Applicants note that Fig. 4H clearly shows that the lower portion of dielectric layer 5 does not extend over element 14, which <u>Dawson</u> clearly discloses as a "trench region," delineated by dashed lines in Figs. 4B-4H. Col. 5, lines 52-54, for example. Applicants respectfully submit, therefore, that the Examiner has improperly associated the lower portion of dielectric layer 5 with part of trench 14, when there is no teaching in <u>Dawson</u> as such. If <u>Dawson</u> intended to include dielectric layer 5 in trench 14, the reference would have shown dashed lines in Fig. 4H extending over dielectric layer 5. Accordingly, dielectric layer 5 also does not correspond to the claimed element isolating insulating film because it is not "provided in the trench," as recited in claim 1.

Moreover, as further shown in Fig. 4H, dielectric layer 5 and trench fill 80 are separated from one another by contact plugs 6, and thus also do not collectively constitute the claimed element isolating insulating film, as recited in claim 1, since contact plugs 6 are necessarily conductive and are neither isolating nor insulating.

Claims 2 and 3 recite limitations similar to those recited in claim 1, and are therefore distinguishable over claim <u>Dawson</u> for reason discussed above in regard to claim 1.

Thus, in view of the above-noted shortcomings of <u>Dawson</u>, claims 1-3 are allowable over the applied reference, and claims 4, 5, and 34-39 are allowable at least due to their corresponding dependence from claims 1-3.

Applicant respectfully requests that this Amendment under 37 C.F.R. § 1.116 be entered by the Examiner, placing claims 1-5 and 34-39 in condition for allowance.

Applicants submit that the proposed amendments of claims 1-4 and 35-39 do not raise new issues or necessitate the undertaking of any additional search of the art by the Examiner. Therefore, this Amendment should allow for immediate action by the Examiner.

Furthermore, Applicants respectfully point out that the final action by the Examiner presented some new arguments as to the application of the art against Applicant's invention. It is respectfully submitted that the entering of the Amendment would allow the Applicants to reply to the final rejections and place the application in condition for allowance.

Finally, Applicants submit that the entry of the amendment would place the application in better form for appeal, should the Examiner dispute the patentability of the pending claims.

In view of the foregoing remarks, Applicants submit that this claimed invention, as amended, is neither anticipated nor rendered obvious in view of the prior art references cited against this application. Applicants therefore request the entry of this Amendment, the Examiner's reconsideration and reexamination of the application, and the timely allowance of the pending claims.

Dated: March 1, 2005

Please grant any extensions of time required to enter this response and charge any additional required fees to our deposit account 06-0916.

Respectfully submitted,

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